

#### Is Now Part of



# ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



June 2016

# HCPL0452, HCPL0453, HCPL0500, HCPL0501, HCPL0530, HCPL0531, HCPL0534 High Speed Transistor Optocouplers

Single Channel: HCPL0452 HCPL0453 HCPL0500 HCPL0501

Dual Channel: HCPL0530 HCPL0531 HCPL0534

#### **Features**

- High speed 1 MBit/s
- 15kV/µs minimum commone mode transient immunity at V<sub>CM</sub> = 1500V (HCPL0453/0534)
- Open collector output
- Guaranteed performance over temperature: 0°C to 70°C
- U.L. recognized (File # E90700)
- VDE0884 recognized (file#136616)
  - approval pending for HCPL0530/0531/0453
  - ordering option V, e.g., HCPL0500V
- BSI recognized (file# 8661, 8662)
  - HCPL0452/0500/0501 only

#### **Applications**

- Line receivers
- Pulse transformer replacement
- Output interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling

#### Description

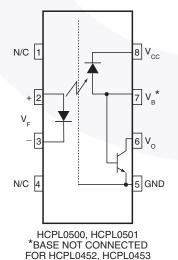
The HCPL05XX, and HCPL04XX optocouplers consist of an AlGaAs LED optically coupled to a high speed photodetector transistor housed in a compact 8-pin small outline package.

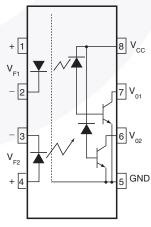
A separate connection for the bias of the photodiode improves the speed by several orders of magnitude over conventional phototransistor optocouplers by reducing the base-collector capacitance of the input transistor. The HCPL04XX devices do not have the base bonded out to a lead for additional noise margin. The HCPL053X devices have two channels per package for optimum mounting density.

# Truth Table (positive Logic)

LED	Vo
ON	LOW
OFF	HIGH

#### **Schematics**





HCPL0530/HCPL0531/HCPL0534

**Absolute Maximum Ratings** ( $T_A = 25^{\circ}$ C unless otherwise specified) Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units
T <sub>STG</sub>	Storage Temperature	-40 to +125	°C
T <sub>OPR</sub>	Operating Temperature	-40 to +85	°C
	Reflow Temperature Profile (Refer to page 11)		
EMITTER			
I <sub>F</sub> (avg)	DC/Average Forward Input Current	25	mA
I <sub>F</sub> (pk)	Peak Forward Input Current (50% duty cycle, 1ms P.W.)	50	mA
I <sub>F</sub> (trans)	Peak Transient Input Current - ([≤1µs P.W., 300 pps)	1.0	А
V <sub>R</sub>	Reverse Input Voltage	5	V
P <sub>D</sub>	Input Power Dissipation	45	mW
DETECTOR			
I <sub>O</sub> (avg)	Average Output Current (Pin 6)	8	mA
I <sub>O</sub> (pk)	Peak Output Current	16	mA
V <sub>EBR</sub>	Emitter-Base Reverse Voltage (HCPL0500/HCPL0501 only)	5	V
V <sub>CC</sub>	Supply Voltage	-0.5 to 30	V
V <sub>O</sub>	Output Voltage	-0.5 to 20	V
I <sub>B</sub>	Base Current (HCPL0500/HCPL0501 only)	5	mA
P <sub>D</sub>	Output power dissipation	100	mW

# **Electrical Characteristics** ( $T_A = 0$ to $70^{\circ}$ C unless otherwise specified)

## **Individual Component Characteristics**

Symbol	Parameter	Test Conditions	Device	Min.	Typ.*	Max.	Unit
EMITTER	1	1	1	1			
V <sub>F</sub>	Input Forward Voltage	I <sub>F</sub> = 16mA, T <sub>A</sub> = 25°C	All		1.45	1.7	V
		I <sub>F</sub> = 16mA				1.8	
BV <sub>R</sub>	Input Reverse Breakdown Voltage	I <sub>R</sub> = 10μA	All	5.0			V
$\Delta V_F / \Delta T_A$	Temperature Coefficient of Forward Voltage	I <sub>F</sub> = 16mA	All		-1.6		mV/°C
DETECTO	R						
I <sub>OH</sub> Logic High Output Current	$I_F = 0mA, V_O = V_{CC} = 5.5V,$ $T_A = 25$ °C	All		0.001	0.5	μA	
		$I_F = 0mA, V_O = V_{CC} = 15V,$ $T_A = 25^{\circ}C$	All		0.005	1	
		$I_F = 0 \text{ mA}, V_O = V_{CC} = 15V$	All			50	
I <sub>CCL</sub>	Logic Low Supply Current	$I_F = 16\text{mA}, V_O = \text{Open},$ $V_{CC} = 15\text{V}$	HCPL0452/3/ 0500/1		120	200	μA
			HCPL0530/1/4			400	
I <sub>CCH</sub> Logic High Supply Current	$I_F = 0$ mA, $V_O = 0$ pen, $V_{CC} = 15$ V, $T_A = 25$ °C	All		0.01	1	μΑ	
		$I_F = 0$ mA, $V_O = 0$ pen, $V_{CC} = 15$ V	HCPL0452/3/ 0500/1			2	
			HCPL0530/1/4			4	

#### **Transfer Characteristics**

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit
COUPLED			•				
CTR	CTR Current Tranfer Ratio $I_F = 16 \text{mA}, V_O = 0.4 \text{V}, V_{CC} = 4.5 \text{V}, T_A = 25 ^{\circ}\text{C}$		HCPL0500/0530	7	27	50	%
		HCPL0452/3	19	27	50		
			HCPL0501/0531				
		$I_F = 16mA, V_O = 0.5V,$	HCPL0500	5	30		
		$V_{CC} = 4.5V$	HCPL0452/3	15	30		
			HCPL0501/0534				
V <sub>OL</sub>	V <sub>OL</sub> Logic Low Output Voltage I <sub>F</sub> = 1	I <sub>F</sub> = 16mA, I <sub>O</sub> = 1.1mA,	HCPL0500		0.18	0.4	V
		$V_{CC} = 4.5V, T_A = 25^{\circ}C$	HCPL0530			0.5	
		$I_F = 16mA, I_O = 3mA,$	HCPL0452/3		0.25	0.4	
		$V_{CC} = 4.5V, T_A = 25^{\circ}C$	HCPL0501/0531/4				
	$I_F = 16mA$ , $I_O = 0.8mA$ , $V_{CC} = 4.5V$ $I_F = 16mA$ , $I_O = 2.4mA$ ,	HCPL0500 HCPL0530		0.13	0.5	R)	
			HCPL0452/3		0.23	0.5	
		$V_{CC} = 4.5V$	HCPL0501/0531/4				

<sup>\*</sup>All typicals at  $T_A = 25$ °C

# **Electrical Characteristics** (Continued) (T<sub>A</sub> = 0 to 70°C unless otherwise specified)

# Switching Characteristics $TV_{CC} = 5V$ )

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit
T <sub>PHL</sub>	Propagation Delay Time to	$T_A = 25^{\circ}\text{C}, R_L = 4.1 \text{k}\Omega, I_F = 16 \text{mA}$ (Note 2) (Fig. 9)	HCPL0500/0530		0.45	1.5	μs
	Logic LOW	$R_L = 1.9k\Omega$ , $I_F = 16mA$ , $T_A = 25^{\circ}C$	HCPL0452/3		0.45	0.8	
	(Note 3) (Fig. 9)	HCPL0501/0531/4					
		$R_L = 4.1 k\Omega$ , $I_F = 16 mA$ (Note 2) (Fig. 9)	HCPL0500/0530			2.0	
		$R_L = 1.9k\Omega$ , $I_F = 16mA$	HCPL0452/3			1.0	
		(Note 3) (Fig. 9)	HCPL0501/0531/4				
T <sub>PLH</sub>	Propagation Delay Time to	$T_A = 25$ °C, $R_L = 4.1$ k $\Omega$ , $I_F = 16$ mA (Note 2) (Fig. 9)	HCPL0500/0530		0.5	1.5	μs
	Logic HIGH	$R_L = 1.9k\Omega$ , $I_F = 16mA$ , $T_A = 25^{\circ}C$	HCPL0452/3		0.3	0.8	
		(Note 3) (Fig. 9)	HCPL0501/0531/4				
		$R_L = 4.1k\Omega$ , $I_F = 16mA$ (Note 2) (Fig. 9)	HCPL0500/0530			2.0	
	/	$R_L = 1.9k\Omega$ , $I_F = 16mA$	HCPL0452/3			1.0	
	7	(Note 3) (Fig. 9)	HCPL0501/0531/4				
ICM <sub>H</sub> I	Common Mode	nsient T <sub>A</sub> = 25°C (Note 4) (Fig. 10) HCPL 0530	HCPL0500	1,000	10,000		V/µs
	Transient Immunity at		HCPL0530				
	$ L_{\text{ogic HIGH}} $ $ I_{\text{F}} = 0\text{mA}, V_{\text{CM}} = 10V_{\text{P-P}}, R_{\text{L}} = 1.9\text{k}\Omega$ $ $ HCF	HCPL0452	1,000 10,000				
		$T_A = 25^{\circ}C$ , (Note 4) (Fig. 10)	HCPL0501/31				
			HCPL0534	15,000	40,000		
		$I_F = 16 \text{mA}, V_{CM} = 1500 V_{P-P}$ $R_L = 1.9 \Omega, T_A = 25 ^{\circ} \text{C}$ (Note 4) (Fig. 10)	HCPL0453	15,000	40,000		
ICM <sub>L</sub> I	Common Mode	$I_F = 16\text{mA}, V_{CM} = 10V_{P-P}, R_L = 4.1k\Omega,$	HCPL0500	1,000	10,000		V/µs
	Immunity at Logic LOW I <sub>F</sub> = 16 mA, V <sub>CM</sub> = 10 V		HCPL0530				
			HCPL0452 1,000	1,000	10,000		
			HCPL0501/31				
			HCPL0534	15,000	40,000		
		$I_F = 16$ mA, $T_A = 25$ °C, $V_{CM} = 1500 V_{P-P} C_L = 15$ pF) (Note 4) (Fig. 10)	HCPL0453	15,000	40,000		

#### **Isolation Characteristics**

Symbol	Characteristics	Test Conditions	Min.	Тур.*	Max.	Unit
V <sub>ISO</sub>	Input-Output Isolation Voltage	$f = 60 \text{ Hz}, t = 1.0 \text{ min.}, I_{I-O} \le 2\mu\text{A}$ (Note 5, 6)	2500			Vac <sub>RMS</sub>
R <sub>ISO</sub>	Isolation Resistance	V <sub>I-O</sub> = 500V (Note 5)	10 <sup>11</sup>			
C <sub>ISO</sub>	Isolation Capacitance	V <sub>I-O</sub> = 0 , f = 1.0MHz (Note 5)		0.2		pF

<sup>\*</sup>All typicals at  $T_A = 25^{\circ}C$ 

#### **Notes**

- 1 Current Transfer Ratio is designed as a ratio of output collector current, I<sub>O</sub>, to the forward LED input current, I<sub>F</sub> times 100%.
- 2. The 4.1 k $\Omega$  load represents 1 LSTTL unit load of 0.36 mA and 6.1k $\Omega$  pull-up resistor.
- 3. The 1.9 k $\Omega$  load represents 1 TTL unit load of 1.6 mA and 5.6 k $\Omega$  pull-up resistor.
- 4. Common mode transient immunity in logic high level is the maximum tolerable (positive)  $dV_{cm}/dt$  on the leading edge of the common mode pulse signal  $V_{CM}$ , to assure that the output will remain in a logic high state (i.e.,  $V_O > 2.0$  V). Common mode transient immunity in logic low level is the maximum tolerable (negative)  $dV_{cm}/dt$  on the trailing edge of the common mode pulse signal,  $V_{CM}$ , to assure that the output will remain in a logic low state (i.e.,  $V_O < 0.8$  V).
- 5. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.
- 6. 2500 VAC RMS for 1 minute duration is equivalent to 3000 VAC RMS for 1 second duration.

## **Typical Performance Curves**

Fig. 2 Normalized CTR vs. Temperature

1.2

1.0

0.8

0.6

Normalized to:

T<sub>A</sub> = 25°C

0.2

0.0

-60

-60

-40

-20

0

20

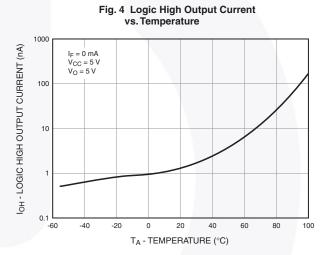
40

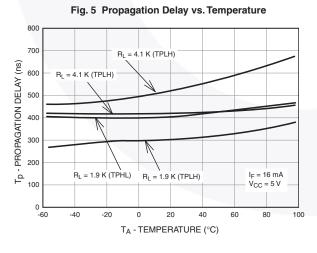
60

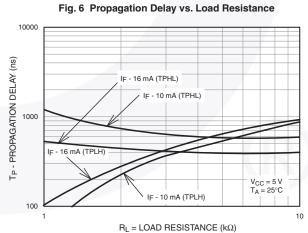
80

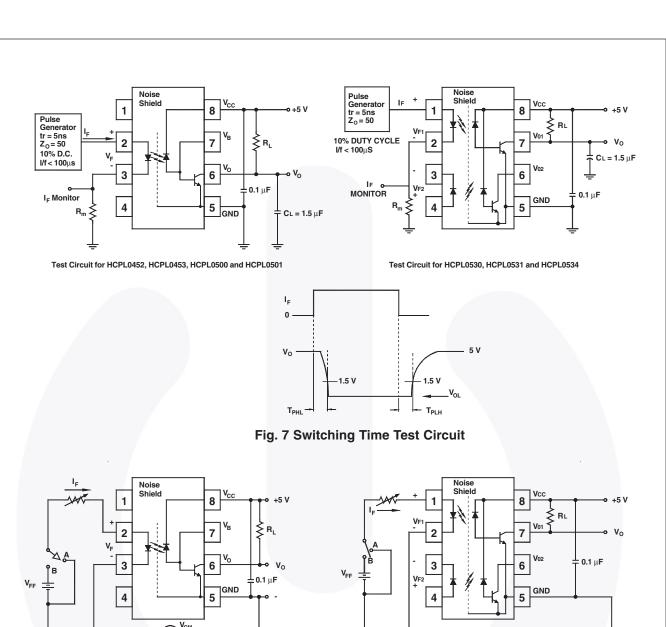
100

T<sub>A</sub> - TEMPERATURE (°C)









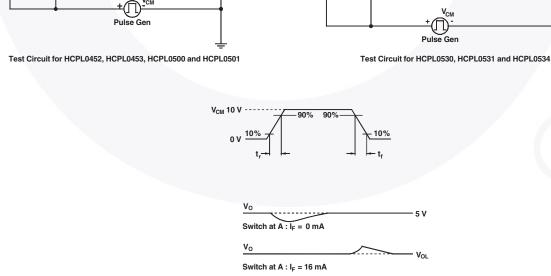
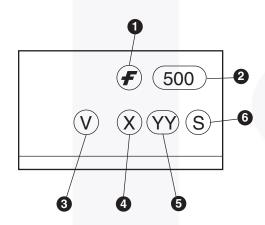


Fig. 8 Common Mode Immunity Test Circuit

# **Ordering Information**

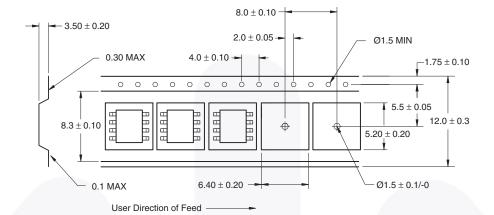
Option	Order Entry Identifier	Description
V	V	VDE 0884 (approval pending for HCPL0530, HCPL0531 & HCPL0534)
R2	R2	Tape and reel (2500 units per reel)
R2V	R2V	VDE 0884 (approval pending for HCPL0530, HCPL0531 & HCPL0534), Tape and reel (2500 units per reel)

# **Marking Infomation**

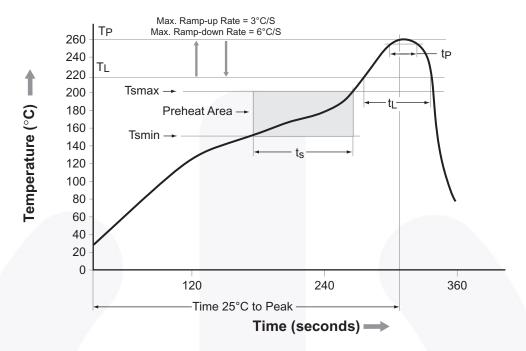


	Definitions
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code, e.g., '3'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

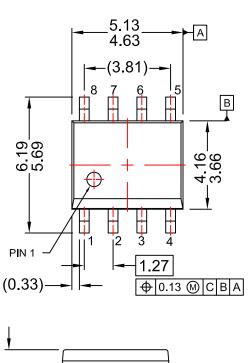
# **Carrier Tape Specifications**

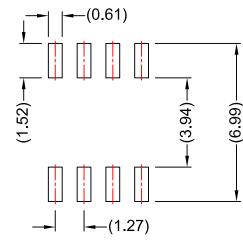


## **Reflow Profile**

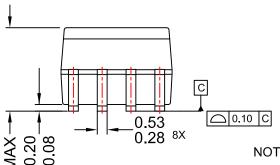


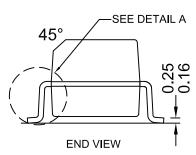
Profile Freature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t <sub>S</sub> ) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60–150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.





LAND PATTERN RECOMMENDATION



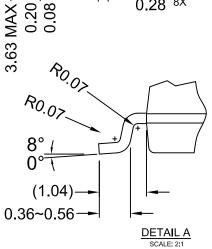






- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M.
- E) DRAWING FILENAME: MKT-M08Erev5





ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor and see no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and h

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative